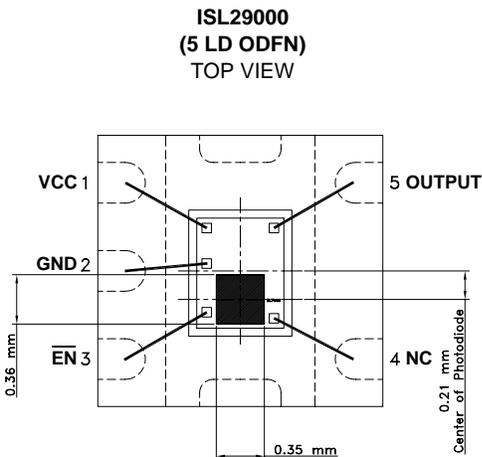


## Ambient Light Photo Detect IC

The ISL29000 is a light-to-current optical sensor combining a photodiode and a current amplifier on a single monolithic IC. Output current is directly proportionate to the light intensity on the photodiode. Its sensitivity is superior to that of a phototransistor and exhibits little variation. Its spectral sensitivity matches closely to the luminous efficiency and linearity.

Housed in an ultra-compact surface mount clear plastic package, this device is excellent for power saving control function in cell phones, PDAs, and other handheld applications.

### Pinout



### Features

- Monolithic IC containing photodiode and amplifier
- Converts light intensity to current
- 2.5V to 5.5V supply range
- Low supply current - 1 $\mu$ A
- Excellent output linearity of luminance
- Ultra-compact and light surface mount package
- Pb-free package (RoHS compliant)

### Applications

- Mobile phones
- Notebook PCs
- PDAs
- Video cameras
- Digital cameras

### Ordering Information

PART NUMBER	TAPE & REEL	PACKAGE	PKG. DWG. #
ISL29000IROZ (See Note)	-	5 Ld ODFN (Pb-free)	MDP0052
ISL29000IROZ-T7 (See Note)	7"	5 Ld ODFN (Pb-free)	MDP0052

NOTE: Intersil Pb-free products employ special Pb-free material sets; molding compounds/die attach materials and 100% matte tin plate termination finish, which are RoHS compliant and compatible with both SnPb and Pb-free soldering operations. Intersil Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020.

**Absolute Maximum Ratings** ( $T_A = 25^\circ\text{C}$ )

Supply Voltage between $V_{SD}$ and GND .....	.6V	Maximum Die Temperature .....	+125°C
Maximum Continuous Output Current .....	6mA	Storage Temperature .....	-65°C to +150°C
Operating Temperature .....	-40°C to +85°C		

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

IMPORTANT NOTE: All parameters having Min/Max specifications are guaranteed. Typical values are for information purposes only. Unless otherwise noted, all tests are at the specified temperature and are pulsed tests, therefore:  $T_J = T_C = T_A$

**Electrical Specifications**  $V_{CC} = 3V$ ,  $T_A = 25^\circ\text{C}$ , fluorescent light, unless otherwise specified.

PARAMETER	DESCRIPTION	CONDITION	MIN	TYP	MAX	UNIT
$I_{CC}$	Supply Current	$R_L = 1k\Omega$ , EV = 1000lx		74		$\mu\text{A}$
		EV = 0		0.2		$\mu\text{A}$
$I_{L1}$	Light Current	EV = 1000lx	45	61	75	$\mu\text{A}$
$I_{L2}$	Light Current	EV = 100lx		6.5		$\mu\text{A}$
$I_{LEAK}$	Dark Current	EV = 0		0.06		$\mu\text{A}$
$V_{O-MAX}$	Maximum Output Compliance Voltage	At 95% of normal output current, EV = 1000lx		2.7		V
$T_R$	Rise Time (See Note)	$R_L = 5k\Omega$ , EV = 1000lx		27	50	$\mu\text{s}$
$T_F$	Fall Time (See Note)	$R_L = 5k\Omega$ , EV = 1000lx		78	110	$\mu\text{s}$
$T_D$	Delay Time for Rising Edge (See Note)	$R_L = 5k\Omega$ , EV = 1000lx		80	110	$\mu\text{s}$
$T_S$	Delay Time for Falling Edge (See Note)	$R_L = 5k\Omega$ , EV = 1000lx		35	50	$\mu\text{s}$
$V_{LO}$	Maximum Voltage at $\overline{EN}$ Pin to Enable				0.6	V
$V_{HI}$	Minimum Voltage at $\overline{EN}$ Pin to Disable		1.8			V

NOTE: Switching time measurement is based on Figures 1 and 2.

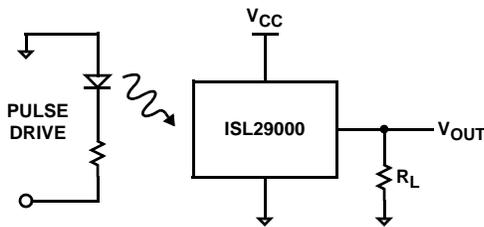


FIGURE 1. RISE/FALL TIME MEASUREMENT

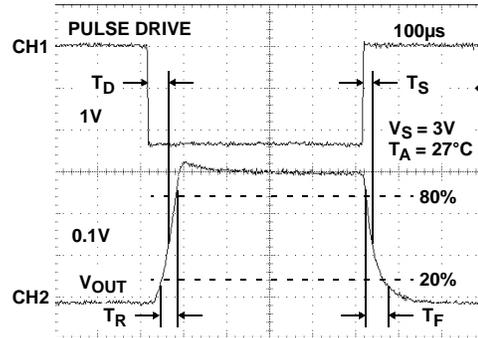


FIGURE 2.

Typical Performance Curves

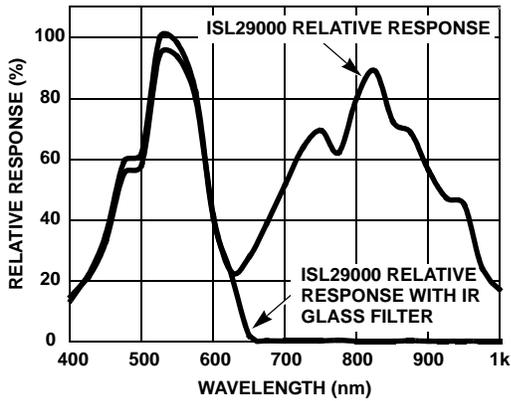


FIGURE 3. SPECTRAL RESPONSE

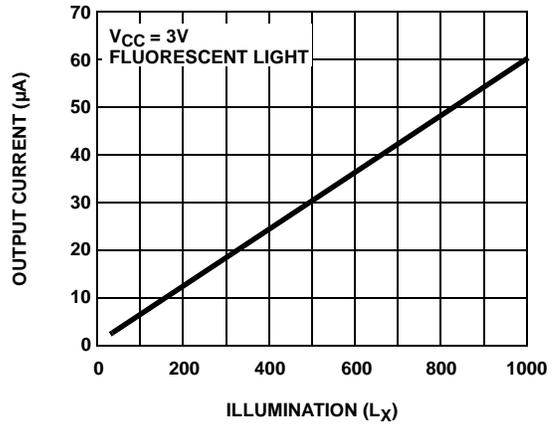


FIGURE 4. SENSITIVITY

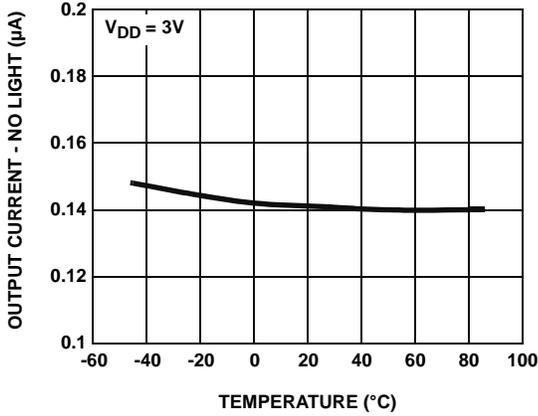


FIGURE 5. DARK CURRENT vs TEMPERATURE

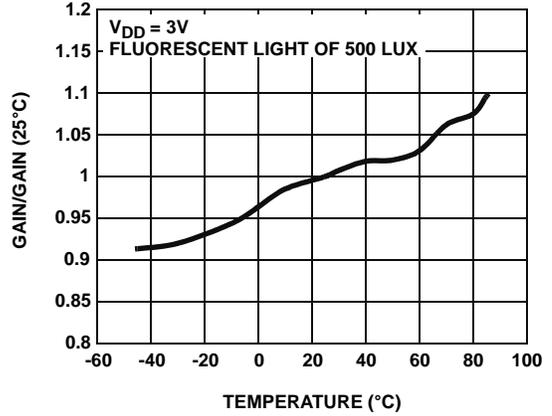


FIGURE 6. GAIN vs TEMPERATURE

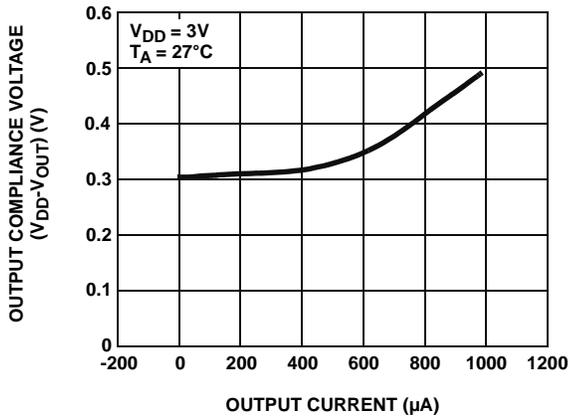


FIGURE 7. OUTPUT COMPLIANCE VOLTAGE vs CURRENT

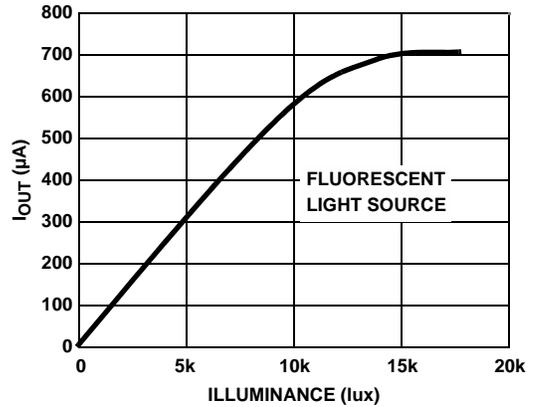
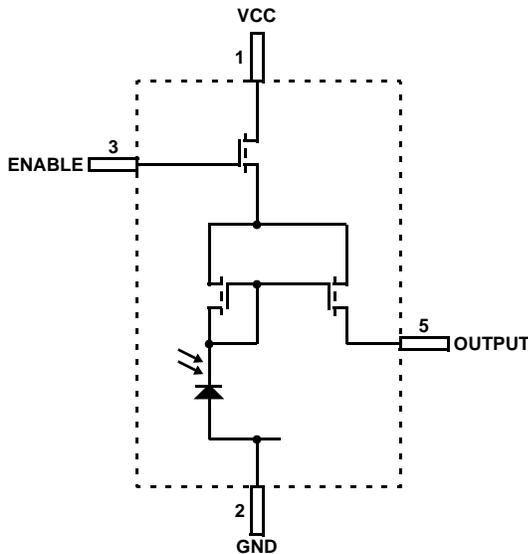


FIGURE 8. I<sub>OUT</sub> vs LUMINANCE

## Pin Descriptions

PIN	NAME	DESCRIPTION
1	VCC	Supply, 2.5V to 5.5V
2	GND	Ground
3	$\overline{\text{EN}}$	Enable
4	NC	No connect
5	Output	Current output pin

## Block Diagram



## Application Information

### Product Description

The ISL29000 is a light-to-current optical sensor combining photodiodes and current amplifiers on a single monolithic IC. The photodiodes are temperature-compensated and their spectrum resembles the human eye response. The output current is directly proportional to the intensity of light falling on the photodiodes. For 100Lux of input fluorescent light, the ISL29000 has an output current of 6.5 $\mu$ A.

The ISL29000 is housed in an ultra-compact surface mount clear plastic package.

### Light-to-Current and Voltage Conversion

The ISL29000 has a responsiveness that is directly proportional to the intensity of light intercepted by the photodiodes. Although the conversion rate varies depending on the light sources (fluorescent light, incandescent light or direct sunlight), in general for a fluorescent light, the light-to-current conversion is:

$$I_{\text{OUT}} = \left( \frac{61\mu\text{A}}{1000\text{Lux}} \right) \times L_{\text{INPUT}}$$

Here,  $I_{\text{OUT}}$  is the output current in  $\mu$ A, and  $L_{\text{INPUT}}$  is the input light in Lux.

For some applications, a load resistor is added between the output and the ground as shown in Figure 1. The output voltage can be expressed in the following equation:

$$V_{\text{OUT}} = I_{\text{OUT}} \times R_{\text{LOAD}} = \left( \frac{61\mu\text{A}}{1000\text{Lux}} \right) \times L_{\text{INPUT}} \times R_{\text{LOAD}}$$

Here,  $V_{\text{OUT}}$  is the output voltage and  $R_{\text{LOAD}}$  is the value of the load resistor added. The compliance of the ISL29000's output circuit may result in premature saturation of the output current and voltage when an excessively large  $R_{\text{LOAD}}$  is used. The output compliance voltage is 300mV below the supply voltage as listed in  $V_{\text{O-max}}$  of Electrical Specifications.

In order to have the linear relationship between the input light and the output current and voltage, a proper resistor value (i.e., gain) should be picked for a specific input light range. The resistor value can be picked according to the following equation:

$$R_{\text{LOAD}} = \frac{(V_{\text{SUP}} - 0.3\text{V})}{61\mu\text{A}} \times \frac{1000\text{Lux}}{L_{\text{RANGE}}}$$

Here,  $V_{\text{SUP}}$  is the supply voltage, and  $L_{\text{RANGE}}$  is the specific input light range for an application. For example, an indoor light ranges typically from 0 to 1,000Lux. A resistor value of 45k $\Omega$  for 3V supply voltage can be used. For a small light range, a large resistor value should be used to achieve better sensitivity; for a large light range, a small resistor value should be used to prevent non-linear output current and voltage.

### Resistor Output $R_{\text{LOAD}}$ Selection.

The resistor output,  $R_{\text{LOAD}}$ , determines the voltage transfer function of the device. The device converts light into current then  $R_{\text{LOAD}}$  converts the output current to an output voltage.  $R_{\text{LOAD}}$  can range from 10 $\Omega$  to 10M $\Omega$  depending on the input lux levels. The table below lists  $R_{\text{LOAD}}$  values to maximize output swing for typical lux range levels. A careful balance of dynamic swing and fast response has to be considered when choosing  $R_{\text{LOAD}}$ . For faster response, choose a smaller value  $R_{\text{LOAD}}$  to shunt stray capacitances that may slow down response time. For maximum dynamic range or swing, choose a higher value  $R_{\text{LOAD}}$ . Although finite, the output impedance of the device is considerably large. Hence, the light-to-current conversion deviation because of resistor loading is infinitesimal. The recommended maximum  $R_{\text{LOAD}}$  is 10M $\Omega$ .

Although the device saturates at 10,000Lux ( $I_{\text{OUT}} = 600\mu\text{A}$ ), the output current must never exceed 6mA. The voltage output compliance of the device is 300mV below the supply. The output current stops ramping when the output voltage reaches voltage compliance.

TABLE 1.  $V_{DD} = 5V$ , MAXIMUM OUTPUT VOLTAGE = 4.7V

ILLUMINATION RANGE (LUX)	RLOAD (kΩ)	CURRENT OUT (μA)
0-10	7830	0-0.6
0-200	392	0-12
0-500	157	0-30
0-1,000	80	0-60
0-10,000	8.00	0-600

**Application Examples**

The following examples present from fully automatic to fully manual override implementations. These guidelines are applicable to a wide variety of potential light control applications. The ISL29000 can be used to control the brightness input of CCFL inverters. Likewise it can interface well with LED drivers. In each specific application, it is important to recognize the target environment and its ambient light conditions. The mechanical mounting of the sensor, light aperture hole size and use of a light pipe or bezel are critical in determining the response of the ISL29000 for a given exposure of light.

The example in Figure 9 shows a fully automatic dimming solution with no user interaction. Choose  $R_1$  and  $R_2$  values for any desired minimum brightness and slope. Choose  $C_1$  to adjust response time and to filter 50/60Hz room lighting. For example, suppose you wish to generate an output voltage from 0.25V to 1.25V to drive the input of an LED driver controller. The 0.25V represents the minimum LED brightness and 1.25V represents the maximum. The 1st step would be to determine the ratio of  $R_1$  and  $R_2$ :

$$R_1 = R_2 \times \left( \frac{3.0V}{0.25V} - 1 \right) = 11 \times R_2$$

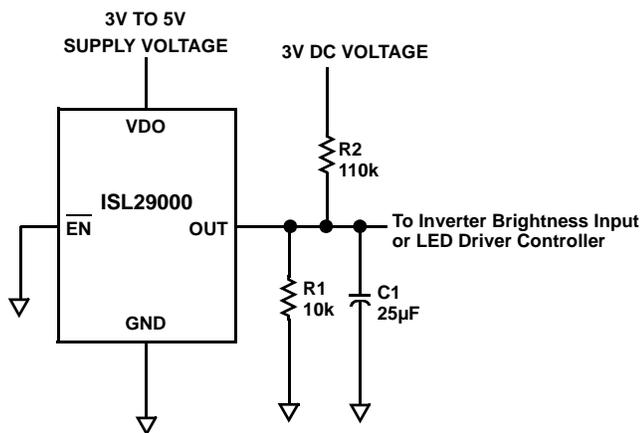


FIGURE 9.

Next the value of  $R_2$  can be calculated based on the maximum output current coming from the ISL29000 under the application's maximum light exposure. Suppose the current has been determined to be about 125μA. Thus  $R_2$  can be calculated approximately as follows:

$$R_2 = \left( \frac{1.25V}{125\mu A} \right) = 10k\Omega$$

and

$$R_1 = 11 \times R_2 = 110k\Omega$$

In Figure 10, user adjustable bias control has been added to allow control over the minimum and maximum output voltage. This allows the user to adjust the output brightness to personal preference over a limit range.

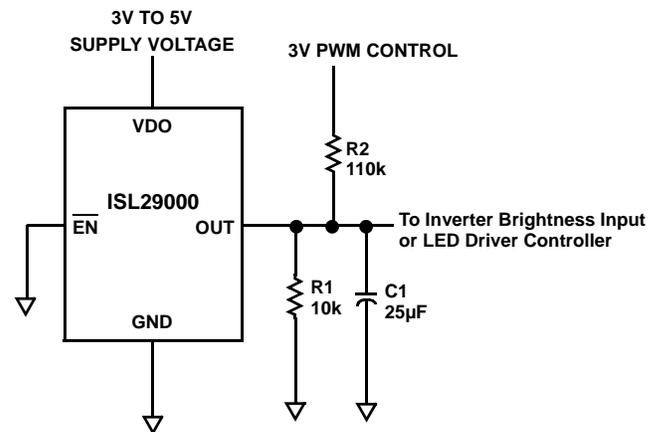


FIGURE 10.

Figure 11 shows how a fully manual override can be quickly added by using the  $\overline{EN}$  pin.

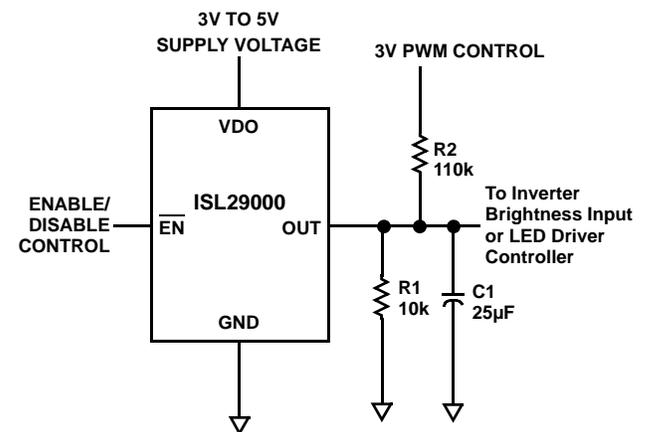


FIGURE 11.

### Short Circuit Current Limit

The ISL29000 does not limit the output short circuit current. If the output is directly shorted to the ground continuously, the output current could easily increase for a strong input light such that the device may be damaged. Maximum reliability is maintained if the output continuous current never exceeds 6mA by adding a load resistor at the output. This limit is set by the design of the internal metal interconnects.

### Suggested PCB Footprint

Footprint pads should be a nominal 1-to-1 correspondence with package pads. The large, exposed central die-mounting paddle in the center of the package requires neither thermal nor electrical connections to PCB, and such connections should be avoided.

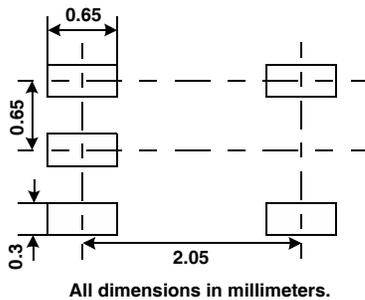
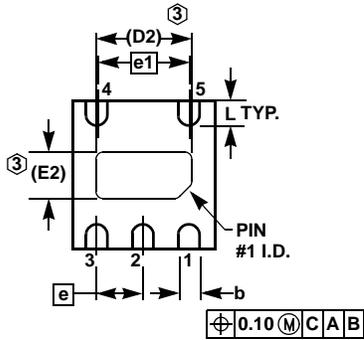
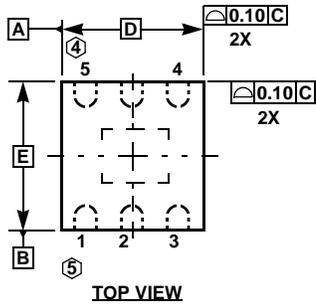


FIGURE 12. SUGGESTED PCB FOOTPRINT

### Power Supply Bypassing and Printed Circuit Board Layout

The ISL29000 is relatively insensitive to the printed circuit board layout due to its low speed operation. Nevertheless, good printed circuit board layout is necessary for optimum performance. Ground plane construction is highly recommended, lead length should be as short as possible and the power supply pins must be well bypassed to reduce the risk of oscillation. For normal single supply operation, where the GND pin is connected to ground, a 0.1 $\mu$ F ceramic capacitor should be placed from V<sub>CC</sub> pin to GND pin. A 4.7 $\mu$ F tantalum capacitor should then be connected in parallel, placed close to the device.

Optical Dual Flat No-Lead Family (ODFN)



MDP0052

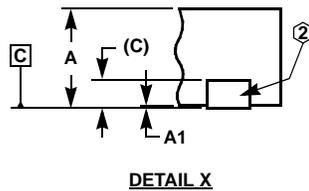
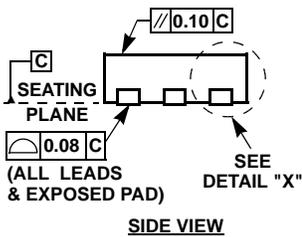
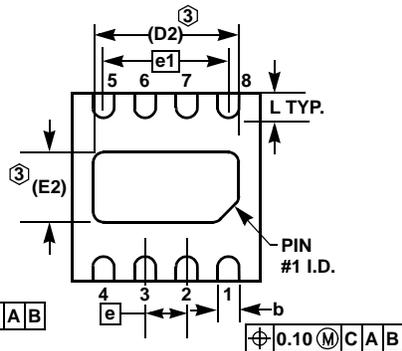
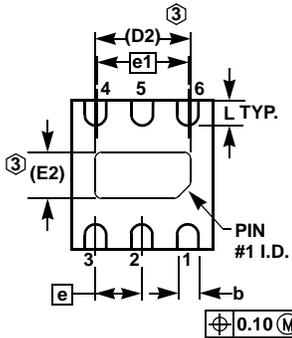
OPTICAL DUAL FLAT NO-LEAD FAMILY

SYMBOL	ODFN5	ODFN6	ODFN8	TOLERANCE	NOTE
A	0.70	0.70	0.70	±0.05	
A1	0.02	0.02	0.02	+0.03/-0.02	
b	0.30	0.30	0.30	±0.05	
c	0.20	0.20	0.20	Reference	2
D	2.00	2.00	3.00	Basic	
D2	1.35	1.35	2.29	Reference	3
E	2.10	2.10	3.00	Basic	
E2	0.65	0.65	1.40	Reference	3
e	0.65	0.65	0.65	Basic	
e1	1.30	1.30	1.95	Basic	
L	0.35	0.35	0.40	±0.05	

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NOTES:

1. Dimensioning and tolerancing per ASME Y14.5M-1994.
2. Exposed lead at side of package is a non-functional feature.
3. Dimension D2 and E2 define the size of the exposed pad.
4. ODFN 5 Ld version has no center lead (shown as dashed line).



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